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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details

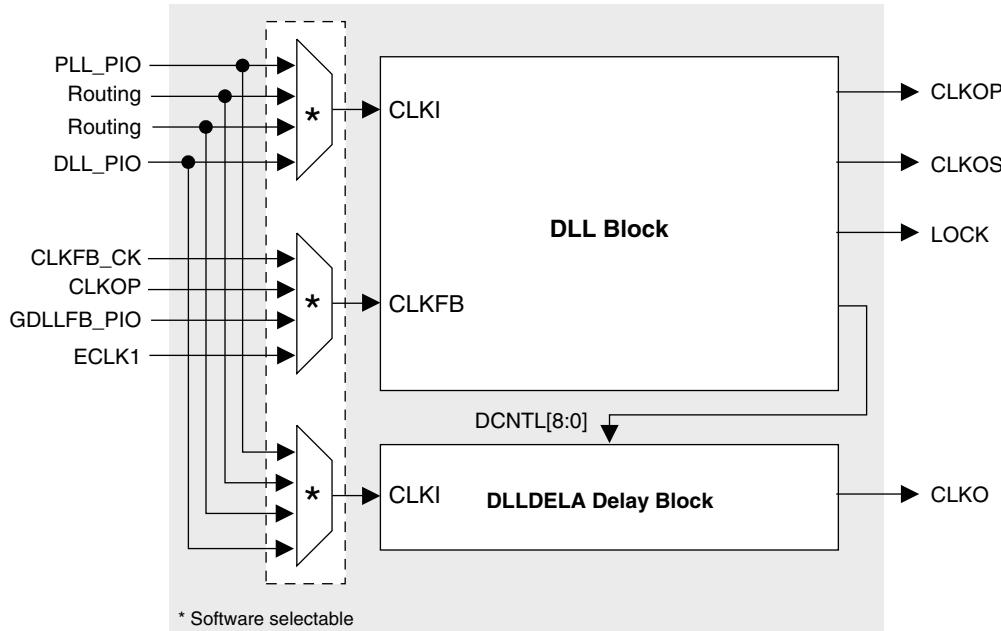
Product Status	Obsolete
Number of LABs/CLBs	8500
Number of Logic Elements/Cells	68000
Total RAM Bits	1056768
Number of I/O	583
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	900-BBGA
Supplier Device Package	900-FPBGA (31x31)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-70se-5f900c

Table 2-5. DLL Signals

Signal	I/O	Description
CLKI	I	Clock input from external pin or routing
CLKFB	I	DLL feed input from DLL output, clock net, routing or external pin
RSTN	I	Active low synchronous reset
ALUHOLD	I	Active high freezes the ALU
UDDCNTL	I	Synchronous enable signal (hold high for two cycles) from routing
DCNTL[8:0]	O	Encoded digital control signals for PIC INDEL and slave delay calibration
CLKOP	O	The primary clock output
CLKOS	O	The secondary clock output with fine phase shift and/or division by 2 or by 4
LOCK	O	Active high phase lock indicator

DLLDELA Delay Block

Closely associated with each DLL is a DLLDELA block. This is a delay block consisting of a delay line with taps and a selection scheme that selects one of the taps. The DCNTL[8:0] bus controls the delay of the CLKO signal. Typically this is the delay setting that the DLL uses to achieve phase alignment. This results in the delay providing a calibrated 90° phase shift that is useful in centering a clock in the middle of a data cycle for source synchronous data. The CLKO signal feeds the edge clock network. Figure 2-7 shows the connections between the DLL block and the DLLDELA delay block. For more information, please see the list of additional technical documentation at the end of this data sheet.

Figure 2-7. DLLDELA Delay Block


PLL/DLL Cascading

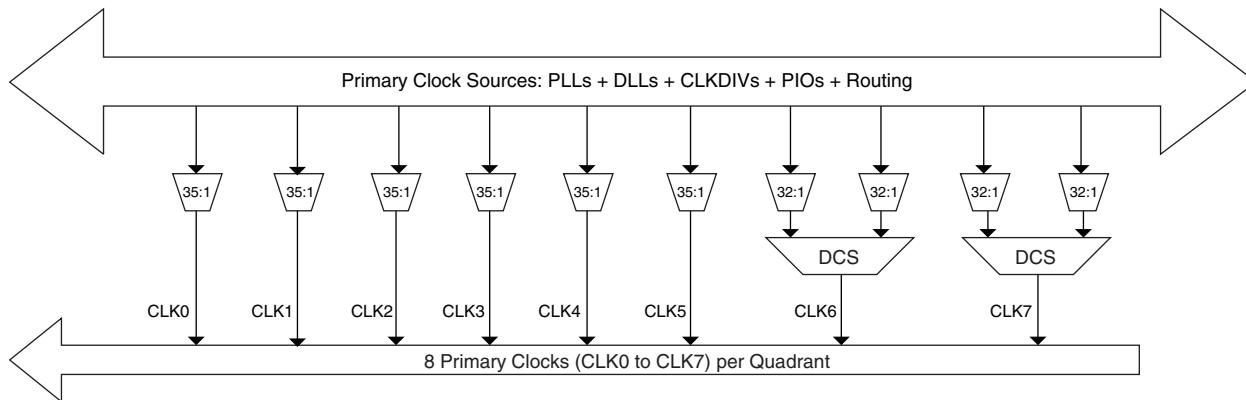
LatticeECP2/M devices have been designed to allow certain combinations of PLL (GPLL and SPLL) and DLL cascading. The allowable combinations are:

- PLL to PLL supported
- PLL to DLL supported

Primary Clock Routing

The clock routing structure in LatticeECP2/M devices consists of a network of eight primary clock lines (CLK0 through CLK7) per quadrant. The primary clocks of each quadrant are generated from muxes located in the center of the device. All the clock sources are connected to these muxes. Figure 2-13 shows the clock routing for one quadrant. Each quadrant mux is identical. If desired, any clock can be routed globally.

Figure 2-13. Per Quadrant Primary Clock Selection

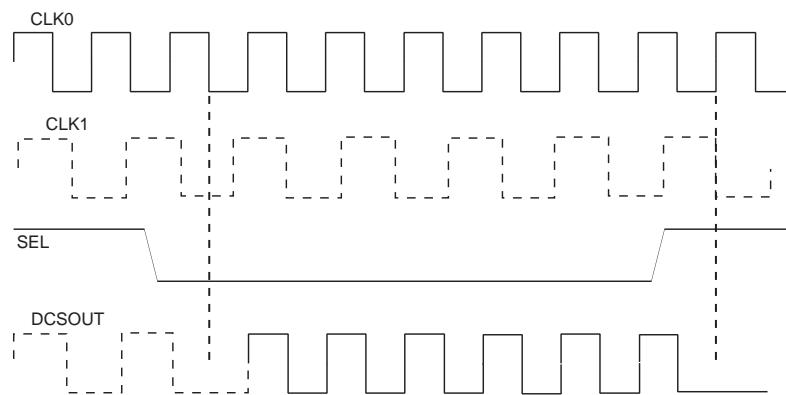


Dynamic Clock Select (DCS)

The DCS is a smart multiplexer function available in the primary clock routing. It switches between two independent input clock sources without any glitches or runt pulses. This is achieved regardless of when the select signal is toggled. There are two DCS blocks per quadrant; in total, there are eight DCS blocks per device. The inputs to the DCS block come from the center muxes. The output of the DCS is connected to primary clocks CLK6 and CLK7 (see Figure 2-13).

Figure 2-14 shows the timing waveforms of the default DCS operating mode. The DCS block can be programmed to other modes. For more information about the DCS, please see the list of additional technical documentation at the end of this data sheet.

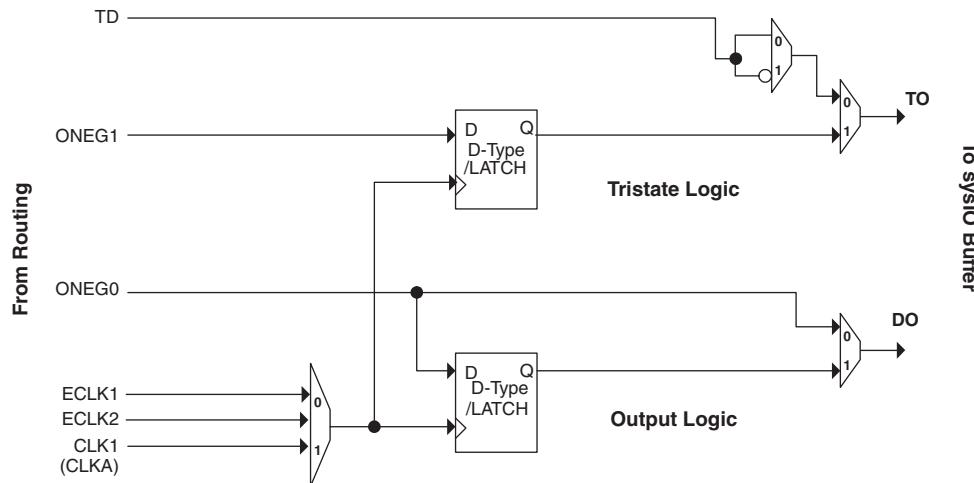
Figure 2-14. DCS Waveforms



Secondary Clock/Control Routing

Secondary clocks in the LatticeECP2 devices are region-based resources. The benefit of region-based resources is the relatively low injection delay and skew within the region, as compared to primary clocks. EBR/DSP rows and a special vertical routing channel bound the secondary clock regions. This special vertical routing channel aligns with either the left edge of the center DSP block in the DSP row or the center of the DSP row. Figure 2-15 shows

Figure 2-32. Output and Tristate Block, Top Edge



Note: Simplified version does not show CE and SET/RESET details.

Tristate Register Block

The tristate register block provides the ability to register tri-state control signals from the core of the device before they are passed to the sysI/O buffers. The block contains a register for SDR operation and an additional latch for DDR operation. Figure 2-31 shows the diagram of the Tristate Register Block with the Output Block for the left, right and bottom edges and Figure 2-32 shows the diagram of the Tristate Register Block with the Output Block for the top edge.

In SDR mode, ONEG1 feeds one of the flip-flops that then feeds the output. The flip-flop can be configured a D-type or latch. In DDR mode, ONEG1 and OPOS1 are fed into registers on the positive edge of the clock. Then in the next clock the registered OPOS1 is latched. A multiplexer running off the same clock cycle selects the correct register for feeding to the output (DO).

Control Logic Block

The control logic block allows the selection and modification of control signals for use in the PIO block. A clock is selected from one of the clock signals provided from the general purpose routing, one of the edge clocks (ECLK1/ ECLK2) and a DQS signal provided from the programmable DQS pin and provided to the input register block. The clock can optionally be inverted.

DDR Memory Support

Certain PICs have additional circuitry to allow the implementation of high speed source synchronous and DDR memory interfaces. The support varies by the edge of the device as detailed below.

Left and Right Edges

PICs on these edges have registered elements that support DDR memory interfaces. One of every 16 PIOs contains a delay element to facilitate the generation of DQS signals. The DQS signal feeds the DQS bus that spans the set of 16 PIOs. Figure 2-33 shows the assignment of DQS pins in each set of 16 PIOs.

Bottom Edge

PICs on the bottom edge have registered elements that support DDR memory interfaces. One of every 18 PIOs contains a delay element to facilitate the generation of DQS signals. The DQS signal feeds the DQS bus that spans the set of 18 PIOs. Figure 2-34 shows the assignment of DQS pins in each set of 18 PIOs.

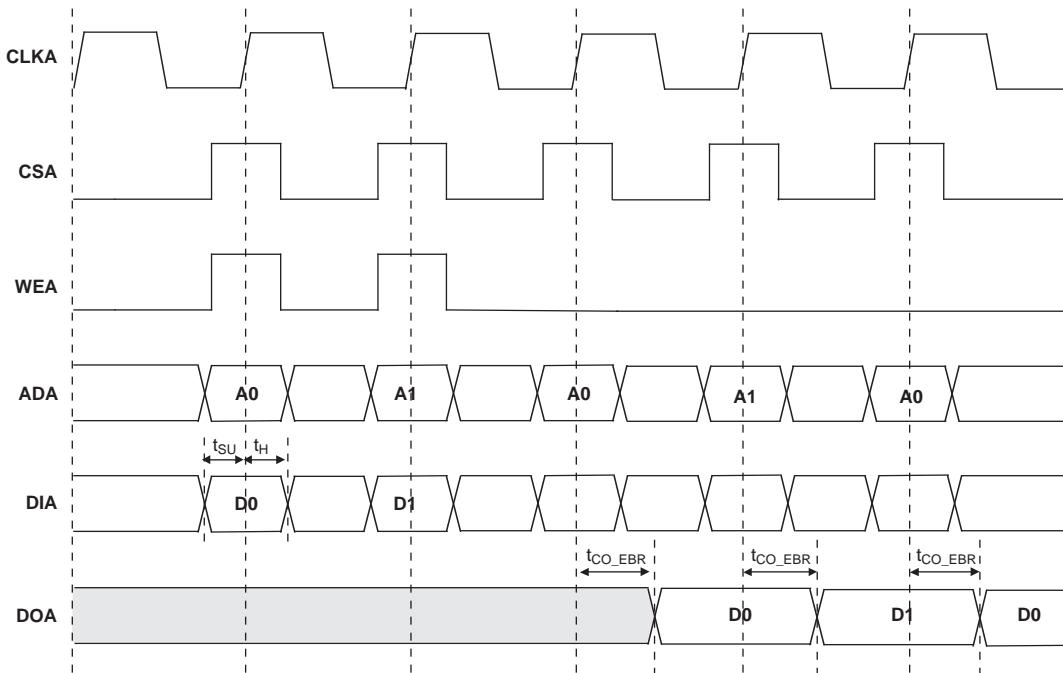
LatticeECP2/M Internal Switching Characteristics¹

Over Recommended Operating Conditions

Parameter	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
PFU/PFF Logic Mode Timing								
t _{LUT4_PFU}	LUT4 delay (A to D inputs to F output)	—	0.180	—	0.198	—	0.216	ns
t _{LUT6_PFU}	LUT6 delay (A to D inputs to OFX output)	—	0.304	—	0.331	—	0.358	ns
t _{LSR_PFU}	Set/Reset to output of PFU (Asynchronous)	—	0.600	—	0.655	—	0.711	ns
t _{SUM_PFU}	Clock to Mux (M0,M1) Input Setup Time	0.128	—	0.129	—	0.129	—	ns
t _{HM_PFU}	Clock to Mux (M0,M1) Input Hold Time	-0.051	—	-0.049	—	-0.046	—	ns
t _{SUD_PFU}	Clock to D input setup time	0.061	—	0.071	—	0.081	—	ns
t _{HD_PFU}	Clock to D input hold time	0.002	—	0.003	—	0.003	—	ns
t _{CK2Q_PFU}	Clock to Q delay, (D-type Register Configuration)	—	0.285	—	0.309	—	0.333	ns
PFU Dual Port Memory Mode Timing								
t _{CORAM_PFU}	Clock to Output (F Port)	—	0.902	—	1.083	—	1.263	ns
t _{SUDATA_PFU}	Data Setup Time	-0.172	—	-0.205	—	-0.238	—	ns
t _{HDATA_PFU}	Data Hold Time	0.199	—	0.235	—	0.271	—	ns
t _{SUADDR_PFU}	Address Setup Time	-0.245	—	-0.284	—	-0.323	—	ns
t _{HADDR_PFU}	Address Hold Time	0.246	—	0.285	—	0.324	—	ns
t _{SUWREN_PFU}	Write/Read Enable Setup Time	-0.122	—	-0.145	—	-0.168	—	ns
t _{HWREN_PFU}	Write/Read Enable Hold Time	0.132	—	0.156	—	0.180	—	ns
PIC Timing								
PIO Input/Output Buffer Timing								
t _{IN_PIO}	Input Buffer Delay (LVCMOS25)	—	0.613	—	0.681	—	0.749	ns
t _{OUT_PIO}	Output Buffer Delay (LVCMOS25)	—	1.115	—	1.115	—	1.343	ns
IOLOGIC Input/Output Timing								
t _{SUI_PIO}	Input Register Setup Time (Data Before Clock)	0.596	—	0.645	—	0.694	—	ns
t _{HI_PIO}	Input Register Hold Time (Data after Clock)	-0.570	—	-0.614	—	-0.658	—	ns
t _{COO_PIO}	Output Register Clock to Output Delay	—	0.61	—	0.66	—	0.72	ns
t _{SUCE_PIO}	Input Register Clock Enable Setup Time	0.032	—	0.037	—	0.041	—	ns
t _{HCE_PIO}	Input Register Clock Enable Hold Time	-0.022	—	-0.025	—	-0.028	—	ns
t _{SULSR_PIO}	Set/Reset Setup Time	0.184	—	0.201	—	0.217	—	ns
t _{HLSR_PIO}	Set/Reset Hold Time	-0.080	—	-0.086	—	-0.093	—	ns
EBR Timing								
t _{CO_EBR}	Clock (Read) to output from Address or Data	—	2.51	—	2.75	—	2.99	ns
t _{COO_EBR}	Clock (Write) to output from EBR output Register	—	0.33	—	0.36	—	0.39	ns
t _{SUDATA_EBR}	Setup Data to EBR Memory	-0.157	—	-0.181	—	-0.205	—	ns
t _{HDATA_EBR}	Hold Data to EBR Memory	0.173	—	0.195	—	0.217	—	ns
t _{SUADDR_EBR}	Setup Address to EBR Memory	-0.115	—	-0.130	—	-0.145	—	ns
t _{HADDR_EBR}	Hold Address to EBR Memory	0.138	—	0.155	—	0.172	—	ns
t _{SUWREN_EBR}	Setup Write/Read Enable to PFU Memory	-0.128	—	-0.149	—	-0.170	—	ns

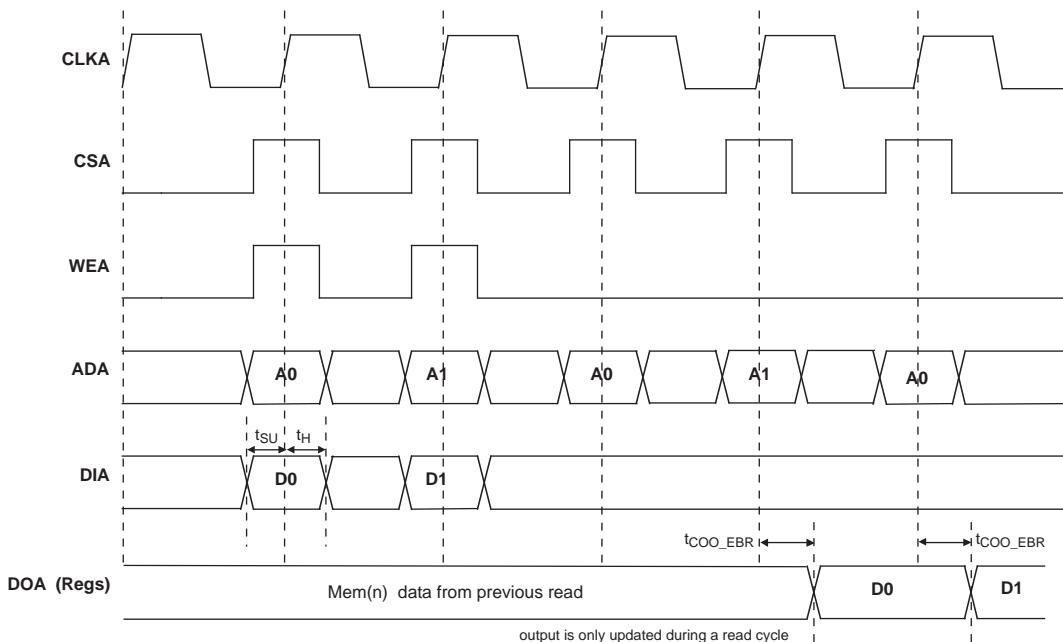
Timing Diagrams

Figure 3-9. Read/Write Mode (Normal)



Note: Input data and address are registered at the positive edge of the clock and output data appears after the positive edge of the clock.

Figure 3-10. Read/Write Mode with Input and Output Registers



LatticeECP2/M Family Timing Adders^{1, 2, 3} (Continued)

Over Recommended Operating Conditions

Buffer Type	Description	-7	-6	-5	Units
HSTL15_I	HSTL_15 class I 4mA drive	-0.22	-0.25	-0.27	ns
HSTL15D_I	Differential HSTL 15 class I 4mA drive	-0.22	-0.25	-0.27	ns
SSTL33_I	SSTL_3 class I	-0.12	-0.15	-0.18	ns
SSTL33_II	SSTL_3 class II	-0.20	-0.23	-0.27	ns
SSTL33D_I	Differential SSTL_3 class I	-0.12	-0.15	-0.18	ns
SSTL33D_II	Differential SSTL_3 class II	-0.20	-0.23	-0.27	ns
SSTL25_I	SSTL_2 class I 8mA drive	-0.16	-0.19	-0.22	ns
SSTL25_II	SSTL_2 class II 16mA drive	-0.19	-0.22	-0.25	ns
SSTL25D_I	Differential SSTL_2 class I 8mA drive	-0.16	-0.19	-0.22	ns
SSTL25D_II	Differential SSTL_2 class II 16mA drive	-0.19	-0.22	-0.25	ns
SSTL18_I	SSTL_1.8 class I	-0.14	-0.17	-0.20	ns
SSTL18_II	SSTL_1.8 class II 8mA drive	-0.20	-0.23	-0.25	ns
SSTL18D_I	Differential SSTL_1.8 class I	-0.14	-0.17	-0.20	ns
SSTL18D_II	Differential SSTL_1.8 class II 8mA drive	-0.20	-0.23	-0.25	ns
LVTTL33_4mA	LVTTL 4mA drive	0.52	0.60	0.68	ns
LVTTL33_8mA	LVTTL 8mA drive	0.06	0.08	0.09	ns
LVTTL33_12mA	LVTTL 12mA drive	0.04	0.04	0.05	ns
LVTTL33_16mA	LVTTL 16mA drive	0.03	0.02	0.02	ns
LVTTL33_20mA	LVTTL 20mA drive	-0.09	-0.09	-0.10	ns
LVCMOS33_4mA	LVCMOS 3.3 4mA drive, fast slew rate	0.52	0.60	0.68	ns
LVCMOS33_8mA	LVCMOS 3.3 8mA drive, fast slew rate	0.06	0.08	0.09	ns
LVCMOS33_12mA	LVCMOS 3.3 12mA drive, fast slew rate	0.04	0.04	0.05	ns
LVCMOS33_16mA	LVCMOS 3.3 16mA drive, fast slew rate	0.03	0.02	0.02	ns
LVCMOS33_20mA	LVCMOS 3.3 20mA drive, fast slew rate	-0.09	-0.09	-0.10	ns
LVCMOS25_4mA	LVCMOS 2.5 4mA drive, fast slew rate	0.41	0.47	0.53	ns
LVCMOS25_8mA	LVCMOS 2.5 8mA drive, fast slew rate	0.01	0.01	0.00	ns
LVCMOS25_12mA	LVCMOS 2.5 12mA drive, fast slew rate	0.00	0.00	0.00	ns
LVCMOS25_16mA	LVCMOS 2.5 16mA drive, fast slew rate	0.04	0.04	0.04	ns
LVCMOS25_20mA	LVCMOS 2.5 20mA drive, fast slew rate	-0.09	-0.10	-0.11	ns
LVCMOS18_4mA	LVCMOS 1.8 4mA drive, fast slew rate	0.37	0.40	0.43	ns
LVCMOS18_8mA	LVCMOS 1.8 8mA drive, fast slew rate	0.10	0.12	0.13	ns
LVCMOS18_12mA	LVCMOS 1.8 12mA drive, fast slew rate	-0.02	-0.02	-0.02	ns
LVCMOS18_16mA	LVCMOS 1.8 16mA drive, fast slew rate	-0.02	-0.03	-0.03	ns
LVCMOS15_4mA	LVCMOS 1.5 4mA drive, fast slew rate	0.29	0.31	0.32	ns
LVCMOS15_8mA	LVCMOS 1.5 8mA drive, fast slew rate	0.05	0.05	0.06	ns
LVCMOS12_2mA	LVCMOS 1.2 2mA drive, fast slew rate	0.58	0.69	0.79	ns
LVCMOS12_6mA	LVCMOS 1.2 6mA drive, fast slew rate	0.13	0.19	0.26	ns
LVCMOS33_4mA	LVCMOS 3.3 4mA drive, slow slew rate	2.17	2.44	2.71	ns
LVCMOS33_8mA	LVCMOS 3.3 8mA drive, slow slew rate	2.50	2.67	2.83	ns
LVCMOS33_12mA	LVCMOS 3.3 12mA drive, slow slew rate	1.72	1.88	2.05	ns
LVCMOS33_16mA	LVCMOS 3.3 16mA drive, slow slew rate	1.64	1.63	1.62	ns
LVCMOS33_20mA	LVCMOS 3.3 20mA drive, slow slew rate	1.33	1.36	1.39	ns

DLL Timing

Over Recommended Operating Conditions

Parameter	Description	Min.	Typ.	Max.	Units
f_{REF}	Input reference clock frequency (on-chip or off-chip)	100	—	500	MHz
f_{FB}	Feedback clock frequency (on-chip or off-chip)	100	—	500	MHz
f_{CLKOP}^1	Output clock frequency, CLKOP	100	—	500	MHz
f_{CLKOS}^2	Output clock frequency, CLKOS	25	—	500	MHz
t_{PJIT}	Output clock period jitter (clean input)		—	250	ps p-p
t_{CYJIT}	Output clock cycle to cycle jitter (clean input)			250	ps p-p
t_{DUTY}	Output clock duty cycle (at 50% levels, 50% duty cycle input clock, 50% duty cycle circuit turned off, time reference delay mode)	35		65	%
$t_{DUTYTRD}$	Output clock duty cycle (at 50% levels, arbitrary duty cycle input clock, 50% duty cycle circuit enabled, time reference delay mode)	40		60	%
$t_{DUTYCIR}$	Output clock duty cycle (at 50% levels, arbitrary duty cycle input clock, 50% duty cycle circuit enabled, clock injection removal mode)	40		60	%
t_{SKEW}^3	Output clock to clock skew between two outputs with the same phase setting	—	—	100	ps
t_{PWH}	Input clock minimum pulse width high (at 80% level)	750	—	—	ps
t_{PWL}	Input clock minimum pulse width low (at 20% level)	750	—	—	ps
t_{INSTB}	Input clock period jitter	—	—	+/-250	ps
t_{LOCK}	DLL lock time	18,500	—	—	cycles
t_{RSWD}	Digital reset minimum pulse width (at 80% level)	3	—	—	ns
t_{PA}	Delay step size	16.5	42	59.4	ps
t_{RANGE1}	Max. delay setting for single delay block (144 taps)	2.376	6	8.553	ns
t_{RANGE4}	Max. delay setting for four chained delay blocks	9.504	24	34.214	ns

1. CLKOP runs at the same frequency as the input clock.

2. CLKOS minimum frequency is obtained with divide by 4.

3. This is intended to be a “path-matching” design guideline and is not a measurable specification.

LatticeECP2 Pin Information Summary, LFE2-6 and LFE2-12

Pin Type	LFE2-6		LFE2-12			
	144 TQFP	256 fpBGA	144 TQFP	208 PQFP	256 fpBGA	484 fpBGA
Single Ended User I/O	90	190	93	131	193	297
Differential Pair User I/O	43	95	45	62	96	148
Configuration	TAP Pins	5	5	5	5	5
	Muxed Pins	14	14	14	14	14
	Dedicated Pins (Non TAP)	7	7	7	7	7
Non Configuration	Muxed Pins	34	54	33	40	54
	Dedicated Pins	3	3	3	3	3
VCC	10	7	10	14	7	16
VCCAUX	4	4	4	8	4	16
VCCPLL	0	0	0	0	0	0
VCCIO	Bank0	1	2	1	2	4
	Bank1	1	2	1	2	4
	Bank2	1	2	1	2	4
	Bank3	1	2	1	2	4
	Bank4	1	2	1	2	4
	Bank5	1	2	1	2	4
	Bank6	1	2	1	2	4
	Bank7	1	2	1	2	4
	Bank8	1	1	1	2	2
GND, GND0 to GND7	12	20	12	22	20	60
NC	4	3	1	0	0	44
Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors)	Bank0	8/4	18/6	8/4	18/9	18/9
	Bank1	17/8	34/17	18/9	18/9	34/17
	Bank2	4/2	20/10	4/2	11/5	20/10
	Bank3	8/4	12/6	8/4	11/5	12/6
	Bank4	18/9	32/16	18/9	19/9	32/16
	Bank5	8/4	14/7	10/5	18/9	17/8
	Bank6	9/4	26/13	9/4	18/8	26/13
	Bank7	12/6	20/10	12/6	12/6	20/10
	Bank8	6/2	14/7	6/2	6/2	14/7
True LVDS I/O Pairs per Bank	Bank0 (Top Edge)	0	0	0	0	0
	Bank1 (Top Edge)	0	0	0	0	0
	Bank2 (Right Edge)	1	5	1	4	5
	Bank3 (Right Edge)	3	3	3	3	4
	Bank4 (Bottom Edge)	0	0	0	0	0
	Bank5 (Bottom Edge)	0	0	0	0	0
	Bank6 (Left Edge)	2	7	2	6	7
	Bank7 (Left Edge)	5	5	5	5	5
	Bank8 (Right Edge)	0	0	0	0	0

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
GND	GND	GNDIO5	-		
R4	R4	PB33A	5	BDQS33	T
L6	L6	PB34A	5	BDQ33	T
T4	T4	PB33B	5	BDQ33	C
L7	L7	PB34B	5	BDQ33	C
N7	N7	PB35A	5	PCLKT5_0/BDQ33	T
VCCIO	VCCIO	VCCIO5	5		
M8	M8	PB35B	5	PCLKC5_0/BDQ33	C
GND	GND	GNDIO5	-		
P7	P7	PB40A	4	PCLKT4_0/BDQ42	T
R8	R8	PB40B	4	PCLKC4_0/BDQ42	C
VCCIO	VCCIO	VCCIO4	4		
T5	T5	PB41A	4	BDQ42	T
T6	T6	PB41B	4	BDQ42	C
T8	T8	PB42A	4	BDQS42	T
GND	GND	GNDIO4	-		
R7	R7	PB43A	4	BDQ42	T
T9	T9	PB42B	4	BDQ42	C
T7	T7	PB43B	4	BDQ42	C
L8	L8	PB44A	4	BDQ42	T
VCCIO	VCCIO	VCCIO4	4		
P8	P8	PB45A	4	BDQ42	T
L9	L9	PB44B	4	BDQ42	C
N8	N8	PB45B	4	BDQ42	C
R9	R9	PB46A	4	BDQ42	T
GND	GND	GNDIO4	-		
R10	R10	PB46B	4	BDQ42	C
-	VCC	VCCIO	4		
-	GND	GNDIO4	4		
N9	N9	PB56A	4	BDQ60	T
T10	T10	PB57A	4	BDQ60	T
M9	M9	PB56B	4	BDQ60	C
R11	R11	PB57B	4	BDQ60	C
P10	P10	PB58A	4	BDQ60	T
N11	N11	PB59A	4	BDQ60	T
VCCIO	VCCIO	VCCIO4	4		
N10	N10	PB58B	4	BDQ60	C
P11	P11	PB59B	4	BDQ60	C
T11	T11	PB60A	4	BDQS60	T
GND	GND	GNDIO4	-		
M11	M11	PB61A	4	BDQ60	T
T12	T12	PB60B	4	BDQ60	C

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
N16	VCCIO3	3			VCCIO3	3			
P16	VCCIO3	3			VCCIO3	3			
R14	VCCIO4	4			VCCIO4	4			
T12	VCCIO4	4			VCCIO4	4			
T13	VCCIO4	4			VCCIO4	4			
T14	VCCIO4	4			VCCIO4	4			
R9	VCCIO5	5			VCCIO5	5			
T10	VCCIO5	5			VCCIO5	5			
T11	VCCIO5	5			VCCIO5	5			
T9	VCCIO5	5			VCCIO5	5			
N7	VCCIO6	6			VCCIO6	6			
P7	VCCIO6	6			VCCIO6	6			
P8	VCCIO6	6			VCCIO6	6			
R8	VCCIO6	6			VCCIO6	6			
J8	VCCIO7	7			VCCIO7	7			
K7	VCCIO7	7			VCCIO7	7			
L7	VCCIO7	7			VCCIO7	7			
M7	VCCIO7	7			VCCIO7	7			
P15	VCCIO8	8			VCCIO8	8			
R15	VCCIO8	8			VCCIO8	8			
A22	GND	-			GND	-			
AA19	GND	-			GND	-			
AA4	GND	-			GND	-			
AB1	GND	-			GND	-			
AB22	GND	-			GND	-			
B19	GND	-			GND	-			
B4	GND	-			GND	-			
C14	GND	-			GND	-			
C9	GND	-			GND	-			
D2	GND	-			GND	-			
D21	GND	-			GND	-			
F17	GND	-			GND	-			
F6	GND	-			GND	-			
H10	GND	-			GND	-			
H11	GND	-			GND	-			
H12	GND	-			GND	-			
H13	GND	-			GND	-			
J14	GND	-			GND	-			
J20	GND	-			GND	-			
J3	GND	-			GND	-			
J9	GND	-			GND	-			
K10	GND	-			GND	-			
K11	GND	-			GND	-			
K12	GND	-			GND	-			
K13	GND	-			GND	-			
K15	GND	-			GND	-			

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
L23	VCCIO2	2			VCCIO2	2			
M17	VCCIO2	2			VCCIO2	2			
M18	VCCIO2	2			VCCIO2	2			
AA23	VCCIO3	3			VCCIO3	3			
R17	VCCIO3	3			VCCIO3	3			
R18	VCCIO3	3			VCCIO3	3			
T23	VCCIO3	3			VCCIO3	3			
V20	VCCIO3	3			VCCIO3	3			
AC16	VCCIO4	4			VCCIO4	4			
AC21	VCCIO4	4			VCCIO4	4			
U15	VCCIO4	4			VCCIO4	4			
V15	VCCIO4	4			VCCIO4	4			
Y18	VCCIO4	4			VCCIO4	4			
AC11	VCCIO5	5			VCCIO5	5			
AC6	VCCIO5	5			VCCIO5	5			
U12	VCCIO5	5			VCCIO5	5			
V12	VCCIO5	5			VCCIO5	5			
Y9	VCCIO5	5			VCCIO5	5			
AA4	VCCIO6	6			VCCIO6	6			
R10	VCCIO6	6			VCCIO6	6			
R9	VCCIO6	6			VCCIO6	6			
T4	VCCIO6	6			VCCIO6	6			
V7	VCCIO6	6			VCCIO6	6			
F4	VCCIO7	7			VCCIO7	7			
J7	VCCIO7	7			VCCIO7	7			
L4	VCCIO7	7			VCCIO7	7			
M10	VCCIO7	7			VCCIO7	7			
M9	VCCIO7	7			VCCIO7	7			
AE25	VCCIO8	8			VCCIO8	8			
V18	VCCIO8	8			VCCIO8	8			
J10	VCCAUX	-			VCCAUX	-			
J11	VCCAUX	-			VCCAUX	-			
J16	VCCAUX	-			VCCAUX	-			
J17	VCCAUX	-			VCCAUX	-			
K18	VCCAUX	-			VCCAUX	-			
K9	VCCAUX	-			VCCAUX	-			
L18	VCCAUX	-			VCCAUX	-			
L9	VCCAUX	-			VCCAUX	-			
T18	VCCAUX	-			VCCAUX	-			
T9	VCCAUX	-			VCCAUX	-			
U18	VCCAUX	-			VCCAUX	-			
U9	VCCAUX	-			VCCAUX	-			
V10	VCCAUX	-			VCCAUX	-			
V11	VCCAUX	-			VCCAUX	-			
V16	VCCAUX	-			VCCAUX	-			
V17	VCCAUX	-			VCCAUX	-			

LFE2-70E/SE Logic Signal Connections: 900 fpBGA

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
VCCIO	VCCIO7	7		
F4	PL2A	7	VREF2_7	T (LVDS)*
F3	PL2B	7	VREF1_7	C (LVDS)*
H4	PL3A	7		T
G5	PL3B	7		C
GND	GNDIO7	-		
D2	PL4A	7		T (LVDS)*
D1	PL4B	7		C (LVDS)*
E2	PL5A	7		T
VCCIO	VCCIO7	7		
E1	PL5B	7		C
GND	GNDIO7	-		
VCCIO	VCCIO7	7		
F1	PL14A	7	LUM1_SPLL_IN_A/LDQ12	T (LVDS)*
F2	PL14B	7	LUM1_SPLLC_IN_A/LDQ12	C (LVDS)*
G1	PL15A	7	LUM1_SPLLFB_IN_A/LDQ12	T
G2	PL15B	7	LUM1_SPLLC_FB_A/LDQ12	C
GND	GNDIO7	-		
H8	PL18A	7	LDQ21	T
H6	PL18B	7	LDQ21	C
VCCIO	VCCIO7	7		
G4	PL19A	7	LDQ21	T (LVDS)*
G3	PL19B	7	LDQ21	C (LVDS)*
H7	PL20A	7	LDQ21	T
H5	PL20B	7	LDQ21	C
GND	GNDIO7	-		
H2	PL21A	7	LDQS21	T (LVDS)*
H1	PL21B	7	LDQ21	C (LVDS)*
J6	PL22A	7	LDQ21	T
VCCIO	VCCIO7	7		
J8	PL22B	7	LDQ21	C
J2	PL23A	7	LDQ21	T (LVDS)*
J1	PL23B	7	LDQ21	C (LVDS)*
J5	PL24A	7	LDQ21	T
GND	GNDIO7	-		
J7	PL24B	7	LDQ21	C
J4	PL25A	7	LDQ29	T (LVDS)*
J3	PL25B	7	LDQ29	C (LVDS)*
K6	PL26A	7	LDQ29	T
K8	PL26B	7	LDQ29	C
VCCIO	VCCIO7	7		
K2	PL27A	7	LDQ29	T (LVDS)*

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AB24	PR87B	8	D3	C
GND	GNDIO4	-		
AB23	PR87A	8	D4	T
AB25	PR86B	8	D5	C
AB26	PR86A	8	D6	T
AC27	PR85B	8	D7/SPID0	C
VCCIO	VCCIO8	8		
AB27	PR85A	8	DI/CSSPI0N	T
AD29	PR84B	8	DOUT/CS0N	C
AD30	PR84A	8	BUSY/SISPI	T
AA25	PR83B	3	RDQ80	C
GND	GNDIO3	-		
AA23	PR83A	3	RDQ80	T
AC29	PR82B	3	RDQ80	C (LVDS)*
AC30	PR82A	3	RDQ80	T (LVDS)*
AA26	PR81B	3	RDQ80	C
VCCIO	VCCIO3	3		
AA24	PR81A	3	RDQ80	T
AB29	PR80B	3	RDQ80	C (LVDS)*
AB30	PR80A	3	RDQS80	T (LVDS)*
GND	GNDIO3	-		
Y23	PR79B	3	RDQ80	C
Y25	PR79A	3	RDQ80	T
AA27	PR78B	3	RDQ80	C (LVDS)*
AA28	PR78A	3	RDQ80	T (LVDS)*
VCCIO	VCCIO3	3		
Y24	PR77B	3	RLM0_GPLL0_FB_A/RDQ80	C
Y26	PR77A	3	RLM0_GPLLT_FB_A/RDQ80	T
AA29	PR76B	3	RLM0_GPLL0_IN_A**/RDQ80	C (LVDS)*
AA30	PR76A	3	RLM0_GPLLT_IN_A**/RDQ80	T (LVDS)*
R22	RLM0_PLLCAP	3		
W23	PR74B	3	RLM0_GDLL0_FB_A/RDQ71	C
W25	PR74A	3	RLM0_GDLLT_FB_A/RDQ71	T
GND	GNDIO3	-		
Y27	PR73B	3	RLM0_GDLL0_IN_A**/RDQ71	C (LVDS)*
Y28	PR73A	3	RLM0_GDLLT_IN_A**/RDQ71	T (LVDS)*
W24	PR72B	3	RDQ71	C
W26	PR72A	3	RDQ71	T
VCCIO	VCCIO3	3		
Y29	PR71B	3	RDQ71	C (LVDS)*
Y30	PR71A	3	RDQS71	T (LVDS)*
V25	PR70B	3	RDQ71	C
GND	GNDIO3	-		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
E21	PT76A	1		T
VCCIO	VCCIO1	1		
B22	PT75B	1		C
A22	PT75A	1		T
H20	PT74B	1		C
F21	PT74A	1		T
F20	PT73B	1		C
GND	GNDIO1	-		
H19	PT73A	1		T
D21	PT72B	1		C
C21	PT72A	1		T
E20	PT71B	1		C
VCCIO	VCCIO1	1		
G21	PT71A	1		T
B21	PT70B	1		C
A21	PT70A	1		T
F19	PT69B	1		C
G20	PT69A	1		T
E19	PT68B	1		C
GND	GNDIO1	-		
G19	PT68A	1		T
D20	PT67B	1		C
VCCIO	VCCIO1	1		
C20	PT67A	1		T
B20	PT66B	1		C
A20	PT66A	1		T
F18	PT65B	1		C
H18	PT65A	1		T
D19	PT64B	1		C
C19	PT64A	1		T
GND	GNDIO1	-		
G18	PT63B	1		C
E18	PT63A	1		T
H17	PT62B	1		C
F17	PT62A	1		T
VCCIO	VCCIO1	1		
G17	PT61B	1		C
E17	PT61A	1		T
B19	PT60B	1		C
A19	PT60A	1		T
GND	GNDIO1	-		
D17	PT59B	1		C
B18	PT59A	1		T

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA

LFE2M20E/SE					LFE2M35E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
D1	PL2A	7	LDQ6	T (LVDS)*	PL2A	7	LDQ6	T (LVDS)*	
E1	PL2B	7	LDQ6	C (LVDS)*	PL2B	7	LDQ6	C (LVDS)*	
F1	PL3A	7	LDQ6	T	PL3A	7	LDQ6	T	
F2	PL3B	7	LDQ6	C	PL3B	7	LDQ6	C	
F5	PL4A	7	LDQ6	T (LVDS)*	PL4A	7	LDQ6	T (LVDS)*	
VCCIO	VCCIO7	7			VCCIO7	7			
G6	PL4B	7	LDQ6	C (LVDS)*	PL4B	7	LDQ6	C (LVDS)*	
F4	PL5A	7	LDQ6	T	PL5A	7	LDQ6	T	
F3	PL5B	7	LDQ6	C	PL5B	7	LDQ6	C	
G1	PL6A	7	LDQS6	T (LVDS)*	PL6A	7	LDQS6	T (LVDS)*	
GNDIO	GNDIO7	-			GNDIO7	-			
G2	PL6B	7	LDQ6	C (LVDS)*	PL6B	7	LDQ6	C (LVDS)*	
H1	PL7A	7	LDQ6	T	PL7A	7	LDQ6	T	
H2	PL7B	7	LDQ6	C	PL7B	7	LDQ6	C	
VCCIO	VCCIO7	7			VCCIO7	7			
H7	PL8A	7	LDQ6	T (LVDS)*	PL8A	7	LDQ6	T (LVDS)*	
H6	PL8B	7	LDQ6	C (LVDS)*	PL8B	7	LDQ6	C (LVDS)*	
G3	PL9A	7	VREF2_7/LDQ6	T	PL9A	7	VREF2_7/LDQ6	T	
H3	PL9B	7	VREF1_7/LDQ6	C	PL9B	7	VREF1_7/LDQ6	C	
GNDIO	GNDIO7	-			GNDIO7	-			
H5	PL11A	7	LUM0_SPLL_IN_A	T (LVDS)*	PL11A	7	LUM0_SPLL_IN_A/LDQ15	T (LVDS)*	
H4	PL11B	7	LUM0_SPLLC_IN_A	C (LVDS)*	PL11B	7	LUM0_SPLLC_IN_A/LDQ15	C (LVDS)*	
J1	PL12A	7	LUM0_SPLLFB_A	T	PL12A	7	LUM0_SPLLFB_A/LDQ15	T	
J2	PL12B	7	LUM0_SPLLC_FB_A	C	PL12B	7	LUM0_SPLLC_FB_A/LDQ15	C	
J3	PL13A	7		T (LVDS)*	PL13A	7	LDQ15	T (LVDS)*	
VCCIO	VCCIO7	7			VCCIO7	7			
J4	PL13B	7		C (LVDS)*	PL13B	7	LDQ15	C (LVDS)*	
J7	PL14A	7		T	PL14A	7	LDQ15	T	
J6	PL14B	7		C	PL14B	7	LDQ15	C	
GNDIO	GNDIO7	-			GNDIO7	-			
VCCIO	VCCIO7	7			VCCIO7	7			
K1	PL18A	7	LUM1_SPLL_IN_A/LDQ22	T (LVDS)*	PL28A	7	LUM1_SPLL_IN_A/LDQ32	T (LVDS)*	
K2	PL18B	7	LUM1_SPLLC_IN_A/LDQ22	C (LVDS)*	PL28B	7	LUM1_SPLLC_IN_A/LDQ32	C (LVDS)*	
J5	PL19A	7	LUM1_SPLLFB_A/LDQ22	T	PL29A	7	LUM1_SPLLFB_A/LDQ32	T	
K5	PL19B	7	LUM1_SPLLC_FB_A/LDQ22	C	PL29B	7	LUM1_SPLLC_FB_A/LDQ32	C	
VCCIO	VCCIO7	7			VCCIO7	7			
K7	PL20A	7	LDQ22	T (LVDS)*	PL30A	7	LDQ32	T (LVDS)*	
K6	PL20B	7	LDQ22	C (LVDS)*	PL30B	7	LDQ32	C (LVDS)*	
L6	PL21A	7	LDQ22	T	PL31A	7	LDQ32	T	
L7	PL21B	7	LDQ22	C	PL31B	7	LDQ32	C	
GNDIO	GNDIO7	-			GNDIO7	-			
L1	PL22A	7	LDQS22	T (LVDS)*	PL32A	7	LDQS32	T (LVDS)*	
L2	PL22B	7	LDQ22	C (LVDS)*	PL32B	7	LDQ32	C (LVDS)*	
M7	PL23A	7	LDQ22	T	PL33A	7	LDQ32	T	
VCCIO	VCCIO7	7			VCCIO7	7			
L5	PL23B	7	LDQ22	C	PL33B	7	LDQ32	C	
L3	PL24A	7	LDQ22	T (LVDS)*	PL34A	7	LDQ32	T (LVDS)*	

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
U12	PB59B	4	BDQ60	C
GNDIO	GNDIO4	-		
AA12	PB60A	4	BDQS60	T
Y12	PB60B	4	BDQ60	C
V12	PB61A	4	BDQ60	T
W12	PB61B	4	BDQ60	C
AB12	PB62A	4	BDQ60	T
AA13	PB62B	4	BDQ60	C
VCCIO	VCCIO4	4		
T12	PB63A	4	BDQ60	T
U13	PB63B	4	BDQ60	C
V13	PB64A	4	BDQ60	T
T13	PB64B	4	BDQ60	C
GNDIO	GNDIO4	-		
AB13	PB65A	4	BDQ69	T
AB14	PB65B	4	BDQ69	C
U14	PB66A	4	BDQ69	T
T14	PB66B	4	BDQ69	C
AA14	PB67A	4	BDQ69	T
VCCIO	VCCIO4	4		
Y14	PB67B	4	BDQ69	C
W14	PB68A	4	BDQ69	T
V14	PB68B	4	BDQ69	C
AB15	PB69A	4	BDQS69	T
GNDIO	GNDIO4	-		
AA15	PB69B	4	BDQ69	C
V15	PB70A	4	BDQ69	T
U15	PB70B	4	BDQ69	C
AB16	PB71A	4	BDQ69	T
VCCIO	VCCIO4	4		
AA16	PB71B	4	BDQ69	C
AB17	PB72A	4	BDQ69	T
AA17	PB72B	4	BDQ69	C
GNDIO	GNDIO4	-		
W20	CFG2	8		
V20	CFG1	8		
V19	CFG0	8		
V22	PROGRAMN	8		
W22	CCLK	8		
U18	INITN	8		
U22	DONE	8		
GNDIO	GNDIO8	-		
U20	WRITEN***	8		

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
G7	PL8A	7	LDQ6	T (LVDS)*	NC	-			
G8	PL6A	7	LDQS6****	T (LVDS)*	NC	-			
G9	PL5A	7	LDQ6	T	NC	-			
H19	NC	-			NC	-			
H20	NC	-			NC	-			
H21	NC	-			NC	-			
H22	NC	-			NC	-			
H6	PL8B	7	LDQ6	C (LVDS)*	NC	-			
H8	PL5B	7	LDQ6	C	NC	-			
H9	PL2A	7	LDQ6	T (LVDS)*	NC	-			
J10	PL2B	7	LDQ6	C (LVDS)*	NC	-			
J20	NC	-			NC	-			
J21	NC	-			NC	-			
J9	PL4A	7	LDQ6	T (LVDS)*	NC	-			
K9	PL4B	7	LDQ6	C (LVDS)*	NC	-			
R9	NC	-			NC	-			
U22	NC	-			NC	-			
W9	NC	-			NC	-			
N13	VCCPLL	-			VCCPLL	-			
N18	VCCPLL	-			VCCPLL	-			
V13	VCCPLL	-			VCCPLL	-			
V18	VCCPLL	-			VCCPLL	-			

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLS or GDLLs within the respective quadrant.

*** These sysCONFIG pins are dedicated I/O pins for configuration. The outputs are actively driven during normal device operation.

****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
D19	PT93B	1		C
E18	PT93A	1		T
D18	PT92B	1		C
C17	PT92A	1		T
A17	PT91B	1		C
B17	PT91A	1		T
GNDIO	GNDIO1	-		
VCCIO	VCCIO1	1		
J18	PT75B	1		C
J19	PT75A	1		T
H17	PT74B	1		C
J17	PT74A	1		T
F18	PT73B	1		C
F17	PT73A	1		T
GNDIO	GNDIO1	-		
A16	PT72B	1		C
B16	PT72A	1		T
G17	PT71B	1		C
G16	PT71A	1		T
VCCIO	VCCIO1	1		
H16	PT70B	1		C
F16	PT70A	1		T
J16	PT69B	1		C
G15	PT69A	1		T
GNDIO	GNDIO1	-		
C16	PT68B	1		C
D16	PT68A	1		T
J15	PT67B	1		C
H15	PT67A	1		T
VCCIO	VCCIO1	1		
A15	PT66B	1	VREF2_1	C
B15	PT66A	1	VREF1_1	T
F15	PT65B	1	PCLKC1_0	C
E16	PT65A	1	PCLKT1_0	T
C15	PT64B	0	PCLKC0_0	C
GNDIO	GNDIO0	-		
D15	PT64A	0	PCLKT0_0	T
C14	PT63B	0	VREF2_0	C
E15	PT63A	0	VREF1_0	T
G14	PT62B	0		C
VCCIO	VCCIO0	0		
J14	PT62A	0		T
F14	PT61B	0		C

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GNDIO	GNDIO1	-			GNDIO1	-		
F19	PT59B	1		C	PT68B	1		C
D18	PT59A	1		T	PT68A	1		T
L18	NC	-			PT67B	1		C
K19	NC	-			PT67A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
A18	PT57B	1	VREF2_1	C	PT66B	1	VREF2_1	C
B18	PT57A	1	VREF1_1	T	PT66A	1	VREF1_1	T
G18	PT56B	1	PCLKC1_0	C	PT65B	1	PCLKC1_0	C
E18	PT56A	1	PCLKT1_0	T	PT65A	1	PCLKT1_0	T
F18	PT55B	0	PCLKC0_0	C	PT64B	0	PCLKC0_0	C
GNDIO	GNDIO0	-			GNDIO0	-		
G19	PT55A	0	PCLKT0_0	T	PT64A	0	PCLKT0_0	T
H18	PT54B	0	VREF2_0	C	PT63B	0	VREF2_0	C
K18	PT54A	0	VREF1_0	T	PT63A	0	VREF1_0	T
VCCIO	VCCIO0	0			VCCIO0	0		
J18	PT53B	0		C	PT60B	0		C
L17	PT53A	0		T	PT60A	0		T
G17	PT52B	0		C	PT59B	0		C
-	-	-			GNDIO0	-		
J17	PT52A	0		T	PT59A	0		T
H17	PT51B	0		C	PT58B	0		C
-	-	-			VCCIO0	0		
K17	PT51A	0		T	PT58A	0		T
B17	PT50B	0		C	PT57B	0		C
GNDIO	GNDIO0	-			-	-		
A17	PT50A	0		T	PT57A	0		T
D17	PT49B	0		C	PT56B	0		C
VCCIO	VCCIO0	0			-	-		
F17	PT49A	0		T	PT56A	0		T
B16	PT48B	0		C	PT55B	0		C
A16	PT48A	0		T	PT55A	0		T
-	-	-			GNDIO0	-		
-	-	-			VCCIO0	0		
E17	PT47B	0		C	PT52B	0		C
C17	PT47A	0		T	PT52A	0		T
K16	PT46B	0		C	PT51B	0		C
J15	PT46A	0		T	PT51A	0		T
GNDIO	GNDIO0	-			GNDIO0	-		
G16	PT45B	0		C	PT50B	0		C
H15	PT45A	0		T	PT50A	0		T
A15	PT44B	0		C	PT49B	0		C
B15	PT44A	0		T	PT49A	0		T
VCCIO	VCCIO0	0			VCCIO0	0		
L16	PT43B	0		C	PT48B	0		C
K15	PT43A	0		T	PT48A	0		T
F16	PT42B	0		C	PT47B	0		C
E16	PT42A	0		T	PT47A	0		T
E15	PT41B	0		C	PT46B	0		C

LatticeECP2 Standard Series Devices, Conventional Packaging

Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6E-5T144C	90	1.2V	-5	TQFP	144	COM	6
LFE2-6E-6T144C	90	1.2V	-6	TQFP	144	COM	6
LFE2-6E-7T144C	90	1.2V	-7	TQFP	144	COM	6
LFE2-6E-5F256C	190	1.2V	-5	fpBGA	256	COM	6
LFE2-6E-6F256C	190	1.2V	-6	fpBGA	256	COM	6
LFE2-6E-7F256C	190	1.2V	-7	fpBGA	256	COM	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12E-5T144C	93	1.2V	-5	TQFP	144	COM	12
LFE2-12E-6T144C	93	1.2V	-6	TQFP	144	COM	12
LFE2-12E-7T144C	93	1.2V	-7	TQFP	144	COM	12
LFE2-12E-5Q208C	131	1.2V	-5	PQFP	208	COM	12
LFE2-12E-6Q208C	131	1.2V	-6	PQFP	208	COM	12
LFE2-12E-7Q208C	131	1.2V	-7	PQFP	208	COM	12
LFE2-12E-5F256C	193	1.2V	-5	fpBGA	256	COM	12
LFE2-12E-6F256C	193	1.2V	-6	fpBGA	256	COM	12
LFE2-12E-7F256C	193	1.2V	-7	fpBGA	256	COM	12
LFE2-12E-5F484C	297	1.2V	-5	fpBGA	484	COM	12
LFE2-12E-6F484C	297	1.2V	-6	fpBGA	484	COM	12
LFE2-12E-7F484C	297	1.2V	-7	fpBGA	484	COM	12

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20E-5Q208C	131	1.2V	-5	PQFP	208	COM	20
LFE2-20E-6Q208C	131	1.2V	-6	PQFP	208	COM	20
LFE2-20E-7Q208C	131	1.2V	-7	PQFP	208	COM	20
LFE2-20E-5F256C	193	1.2V	-5	fpBGA	256	COM	20
LFE2-20E-6F256C	193	1.2V	-6	fpBGA	256	COM	20
LFE2-20E-7F256C	193	1.2V	-7	fpBGA	256	COM	20
LFE2-20E-5F484C	331	1.2V	-5	fpBGA	484	COM	20
LFE2-20E-6F484C	331	1.2V	-6	fpBGA	484	COM	20
LFE2-20E-7F484C	331	1.2V	-7	fpBGA	484	COM	20
LFE2-20E-5F672C	402	1.2V	-5	fpBGA	672	COM	20
LFE2-20E-6F672C	402	1.2V	-6	fpBGA	672	COM	20
LFE2-20E-7F672C	402	1.2V	-7	fpBGA	672	COM	20